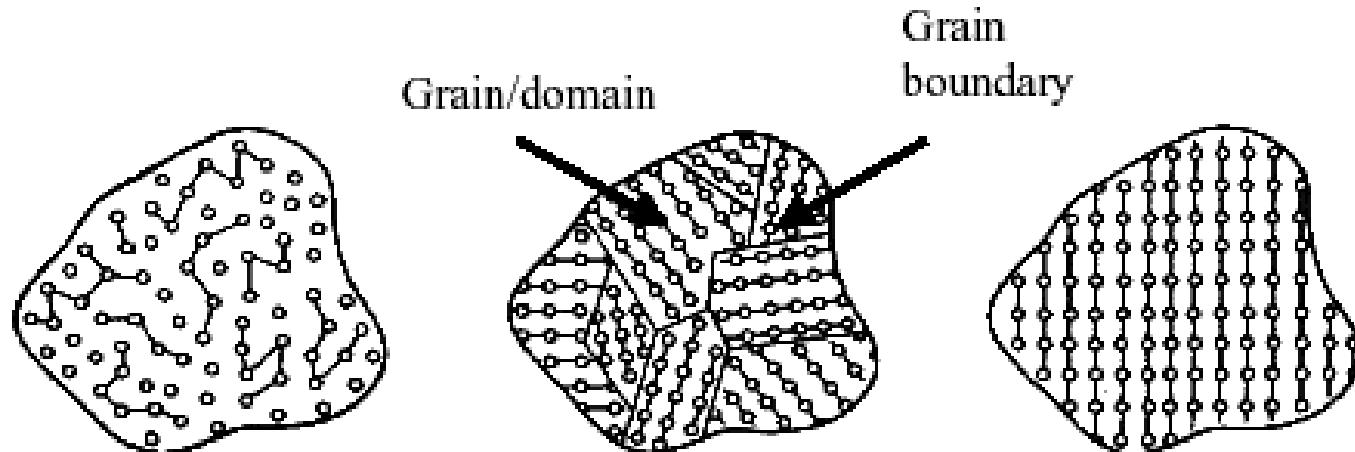
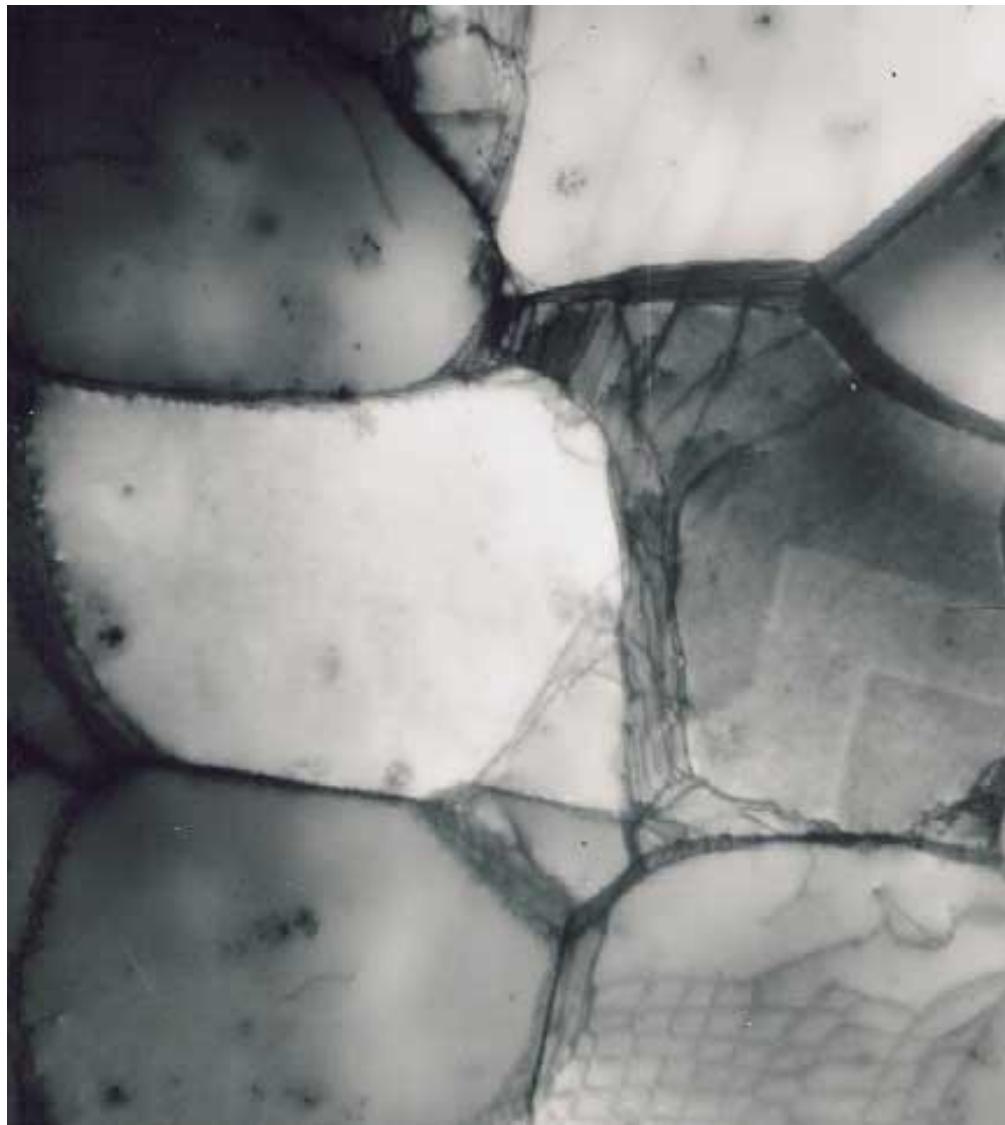


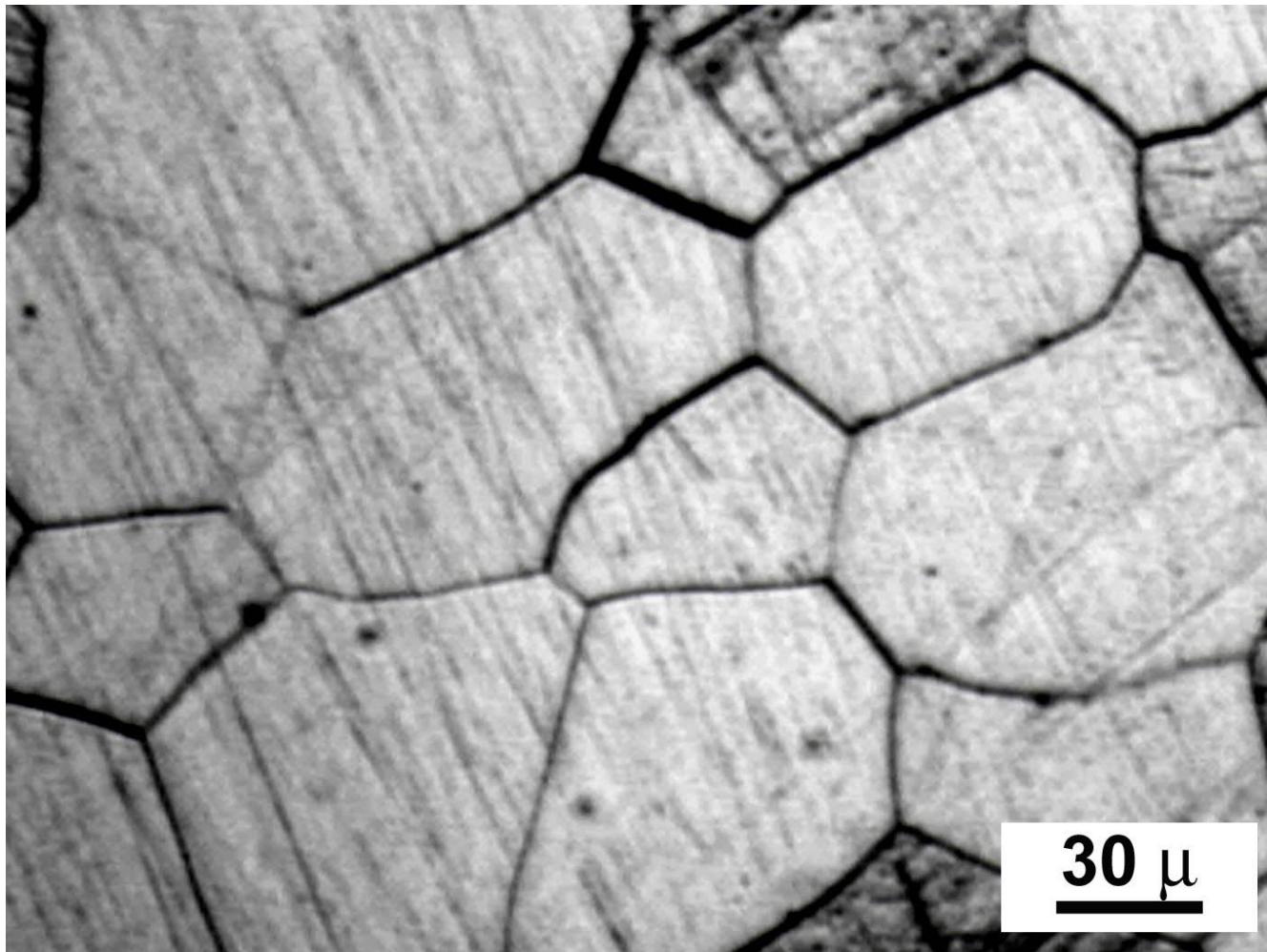
crystalline structures

materials:
amorphous – polycrystalline – monocristalline





TEM, Al film



steel

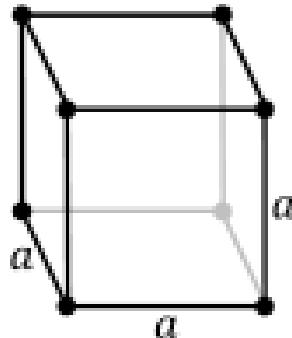
acid etched
surface

30 μ



natural
diamonds

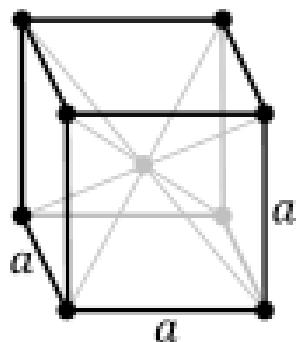
crystal lattices:



Simple Cubic lattice

Po

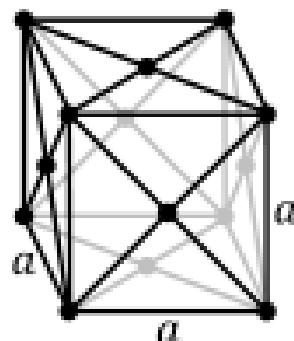
52 % filling



Body Centered Cubic lattice, BCC

α -Fe, Li, Na, K, Na, Mo, Cr, W

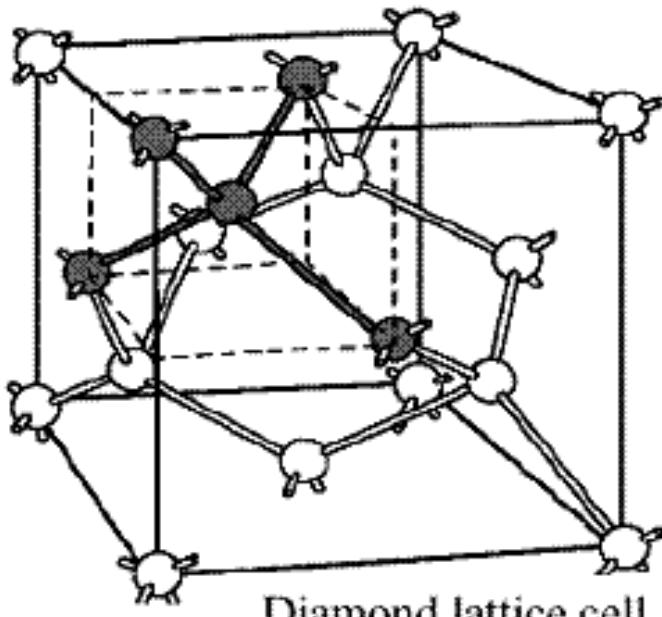
68 % filling



Face Centered Cubic lattice, FCC

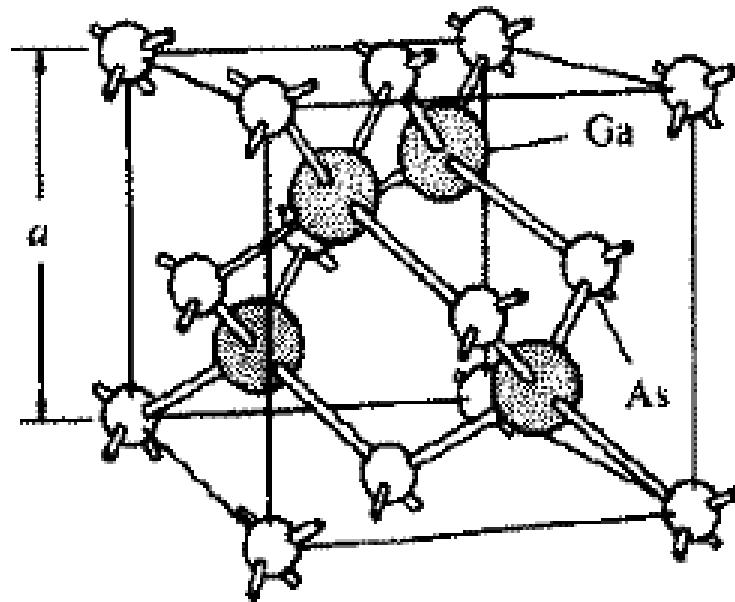
Cu, Ag, Au, Al, Ca, Ni, Pb, Pt, Pd, α -Fe

74 % filling

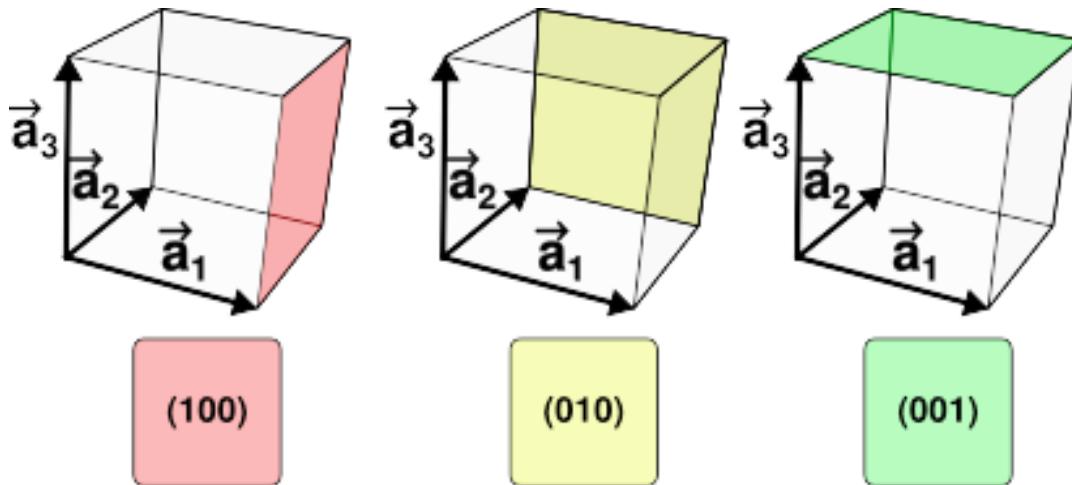


diamond lattice
(C, Si, Ge, Sn)

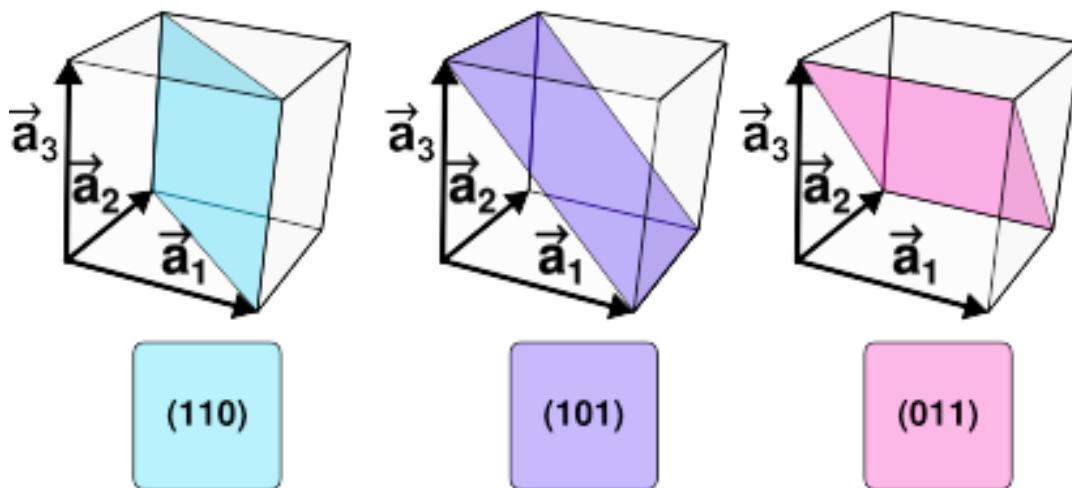
34 % filling



zincblende lattice
(ZnS, GaAs,CdTe, InP, ZnSe)



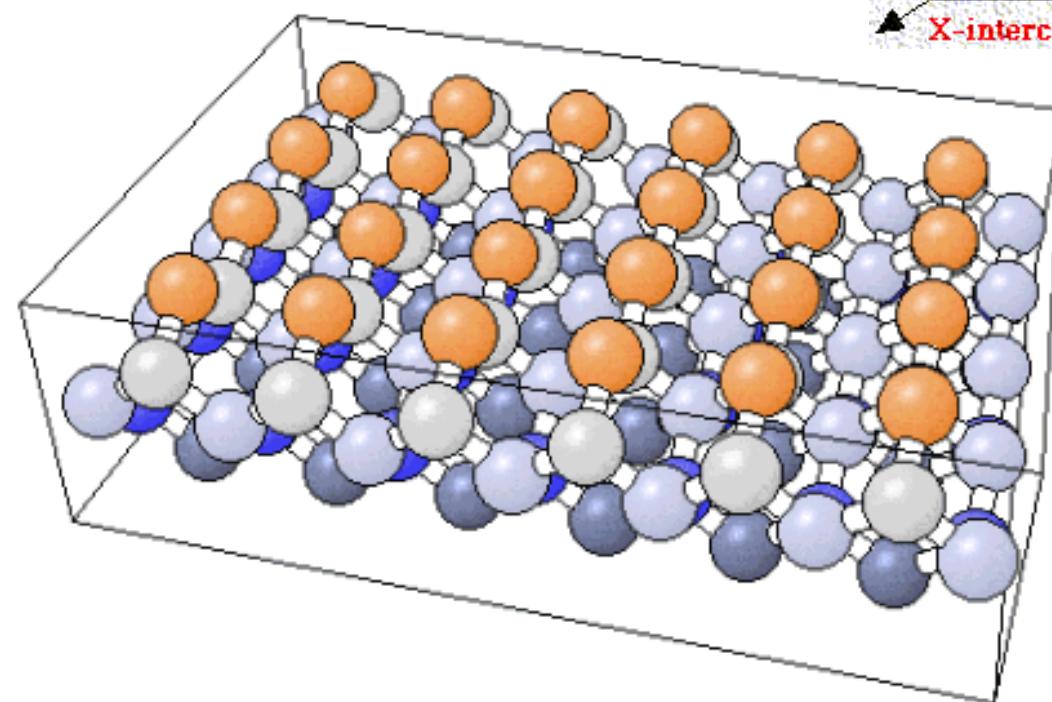
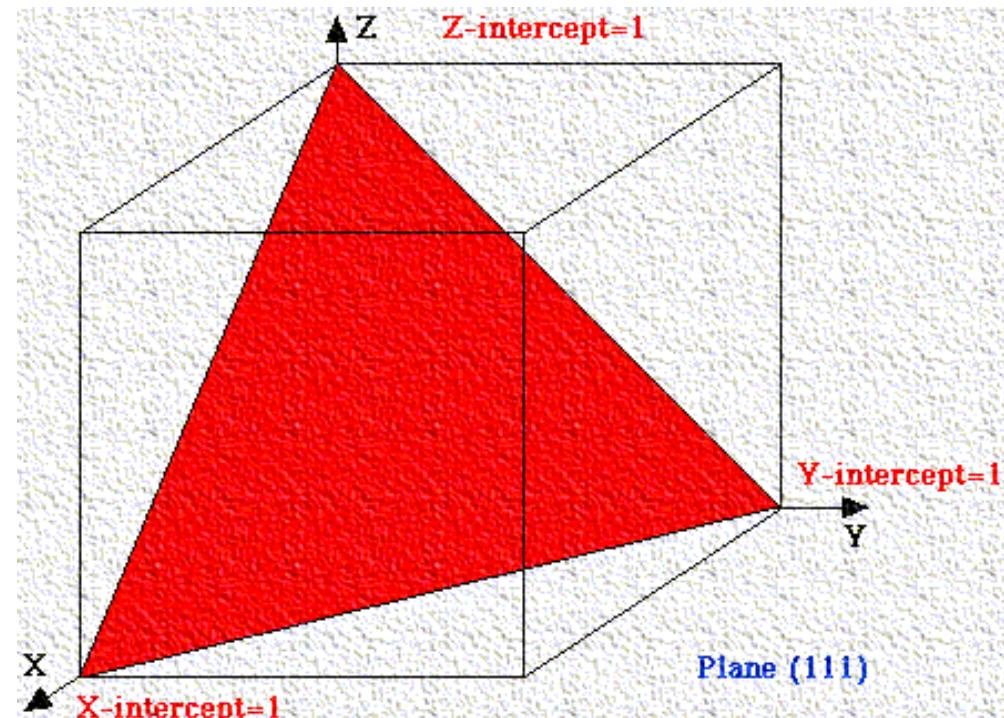
Miller indices (hkl)
describe crystal planes



identical properties
in cubic lattice:
100 = 010 = 001

electronic properties
depend on crystal plane

Si (111) plane



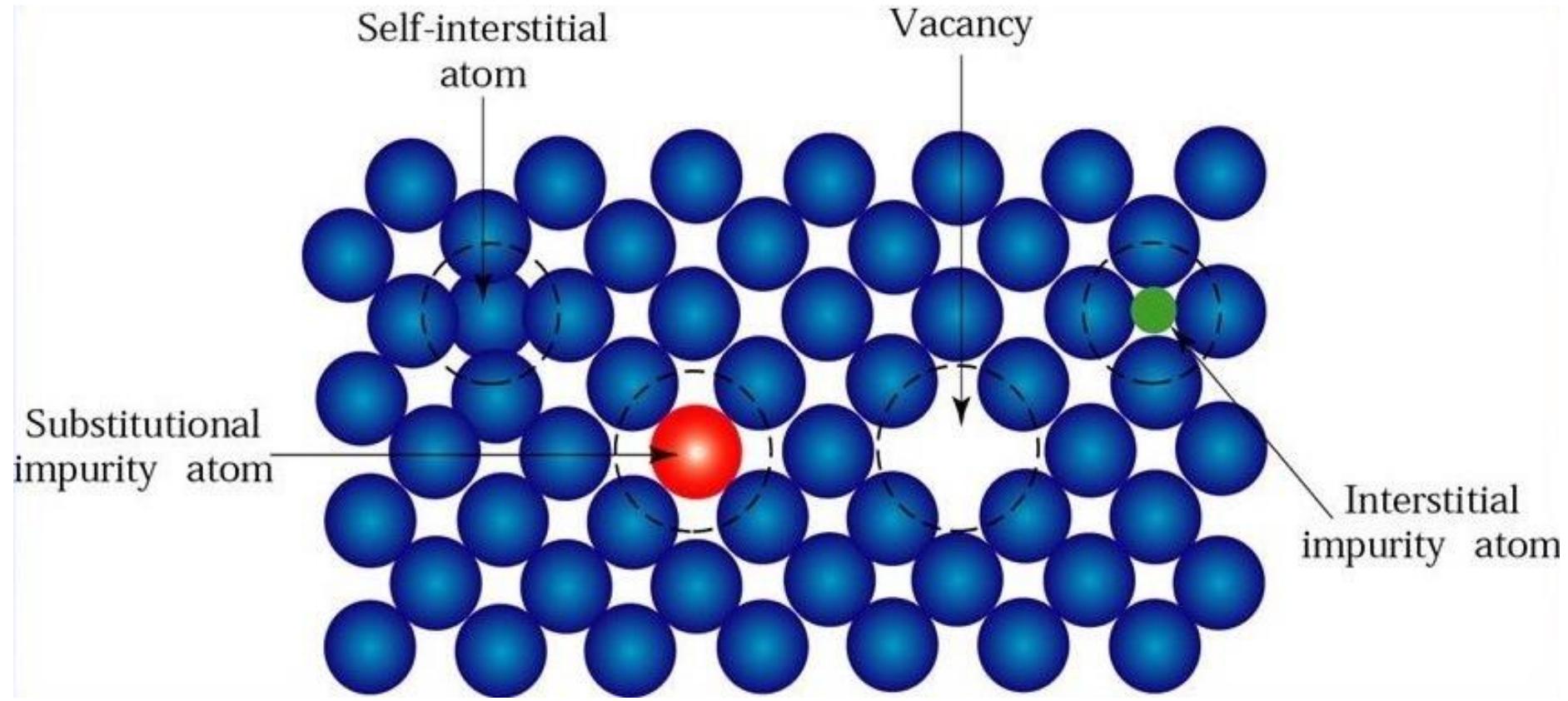
(100) has lesser atom density

- lesser current density
- lesser transistor capacity
- lesser crystal growth rate
- lesser oxidation rate

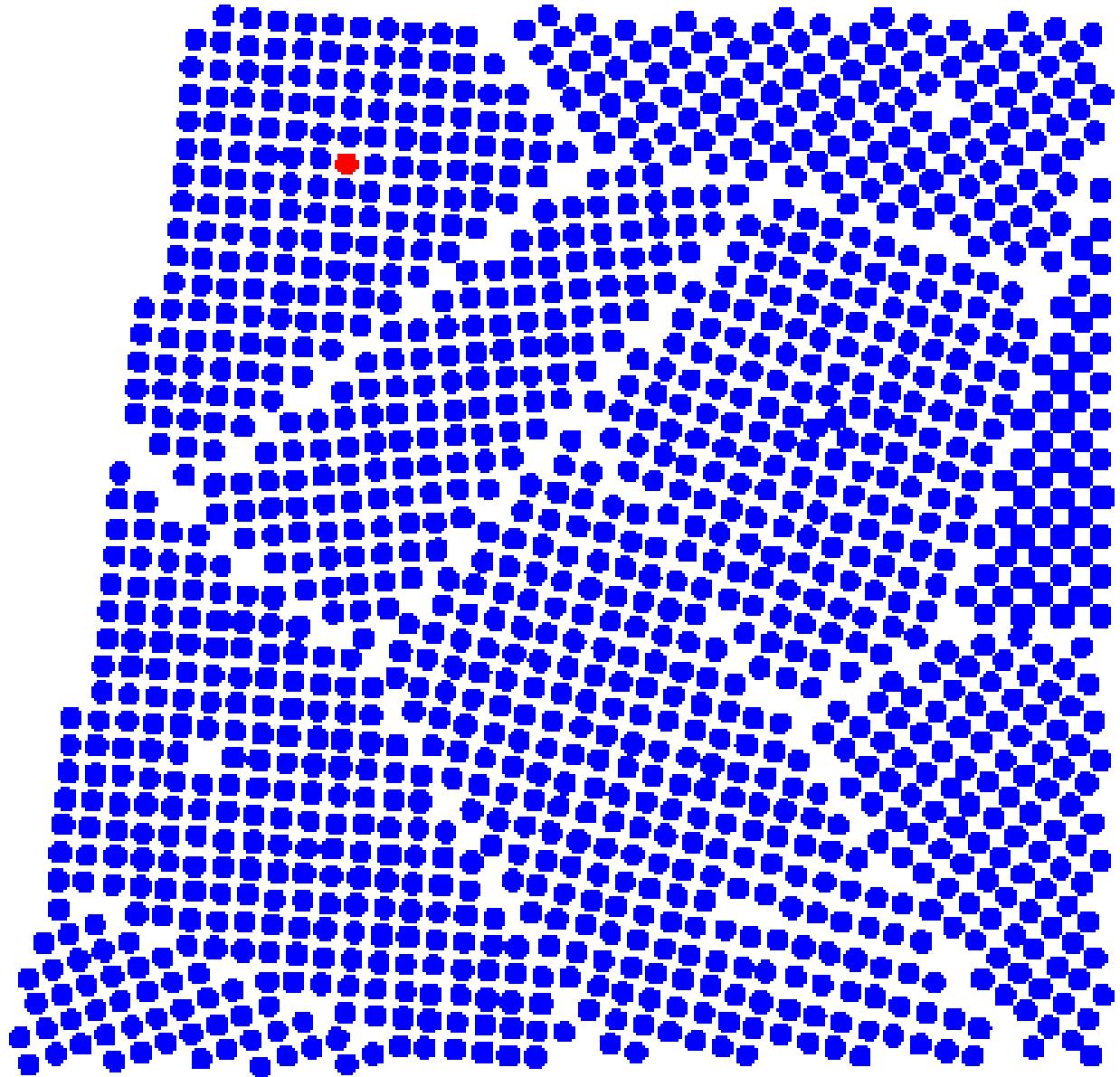
(100) is used for MOS FET

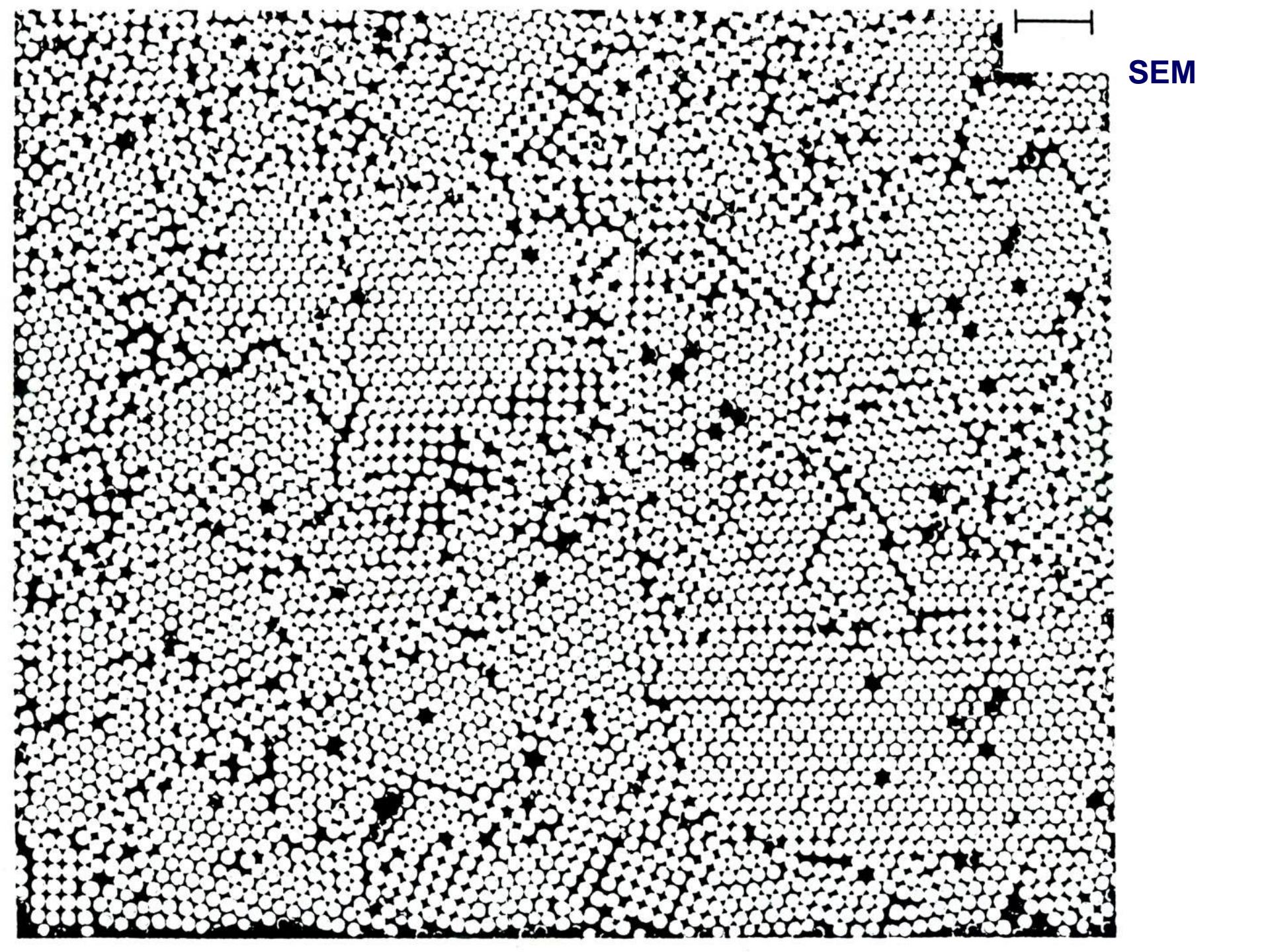
(111) hi power bipolar transistors

point defects

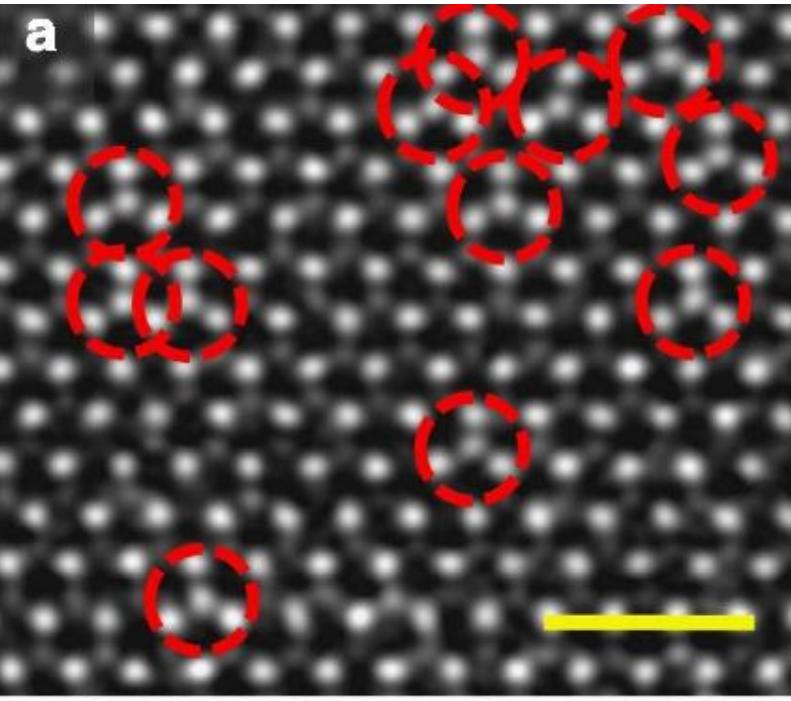


defects +
crystallites





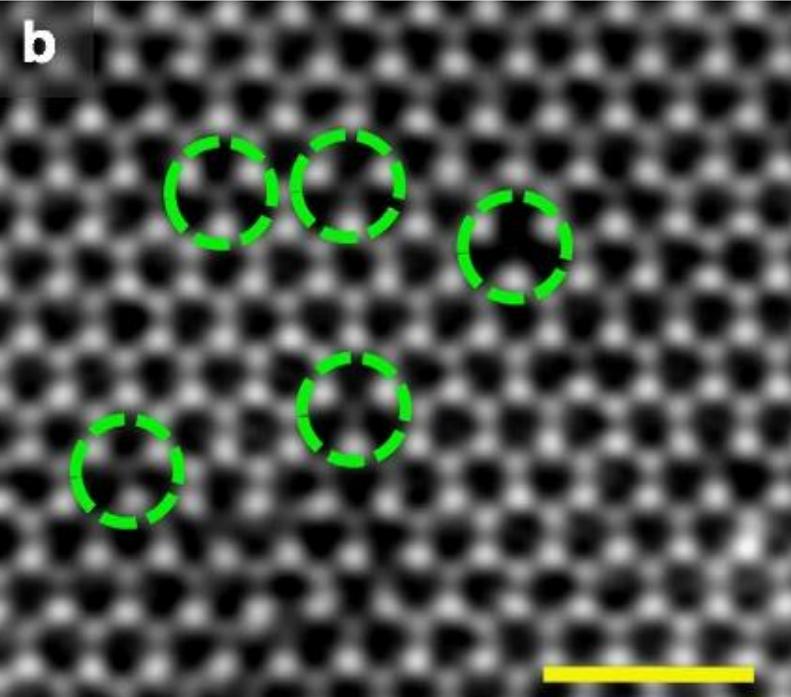
SEM



TEM

MoS₂ monolayer

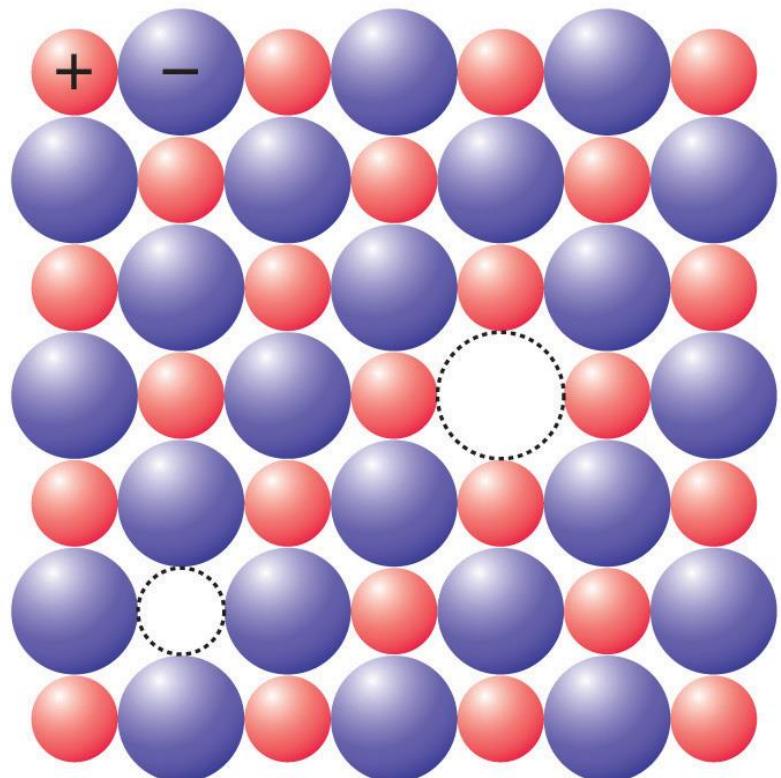
Mo substituted by S



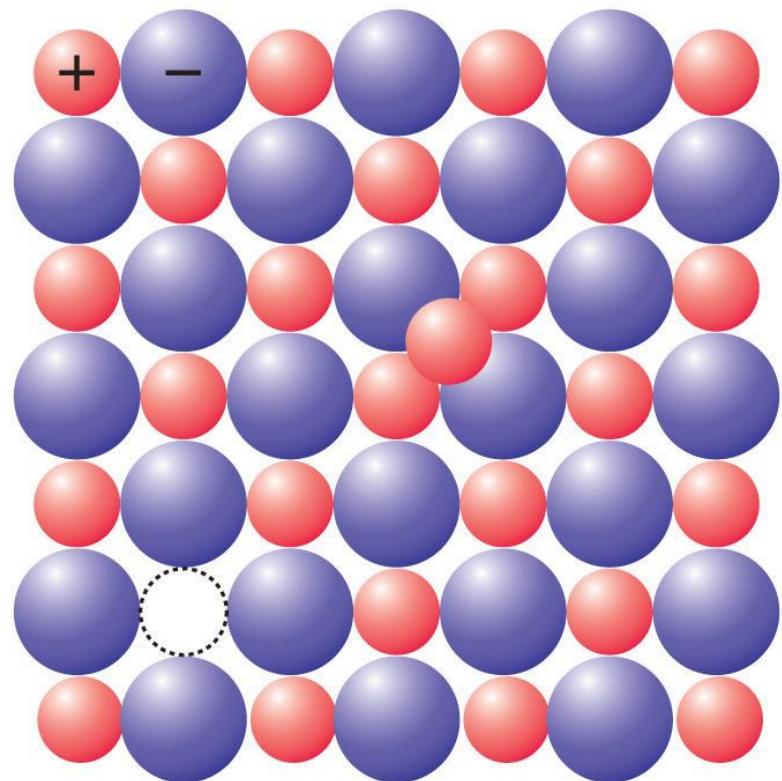
lack of S

scale 1 nm

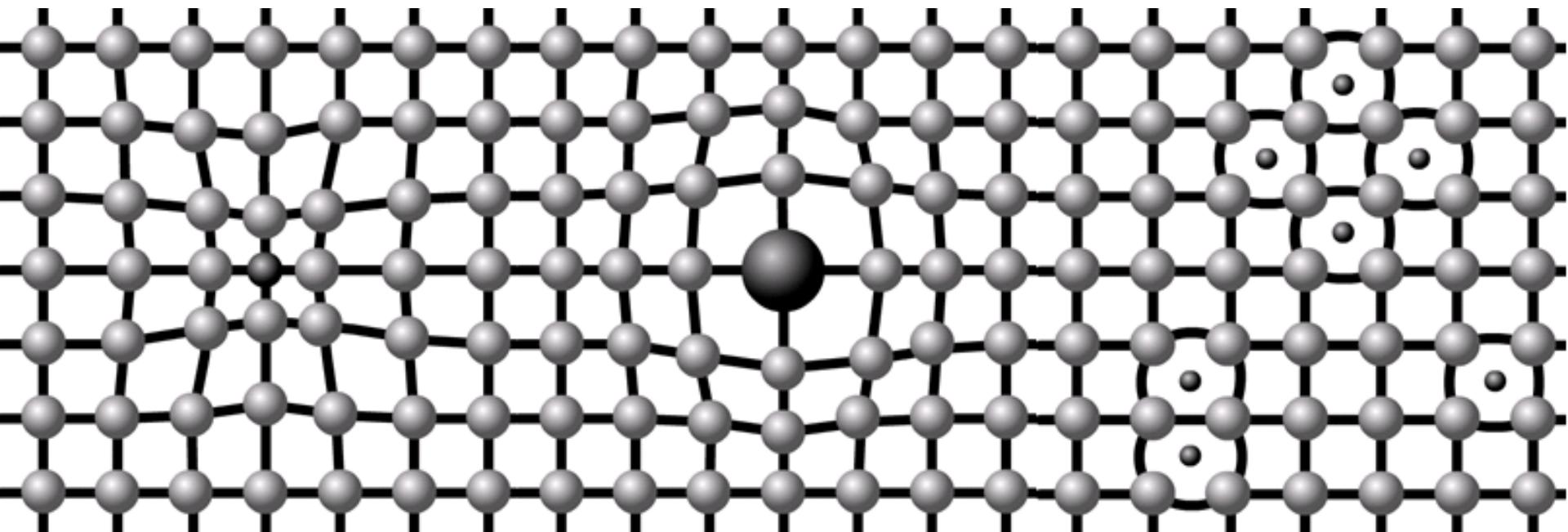
paired defects



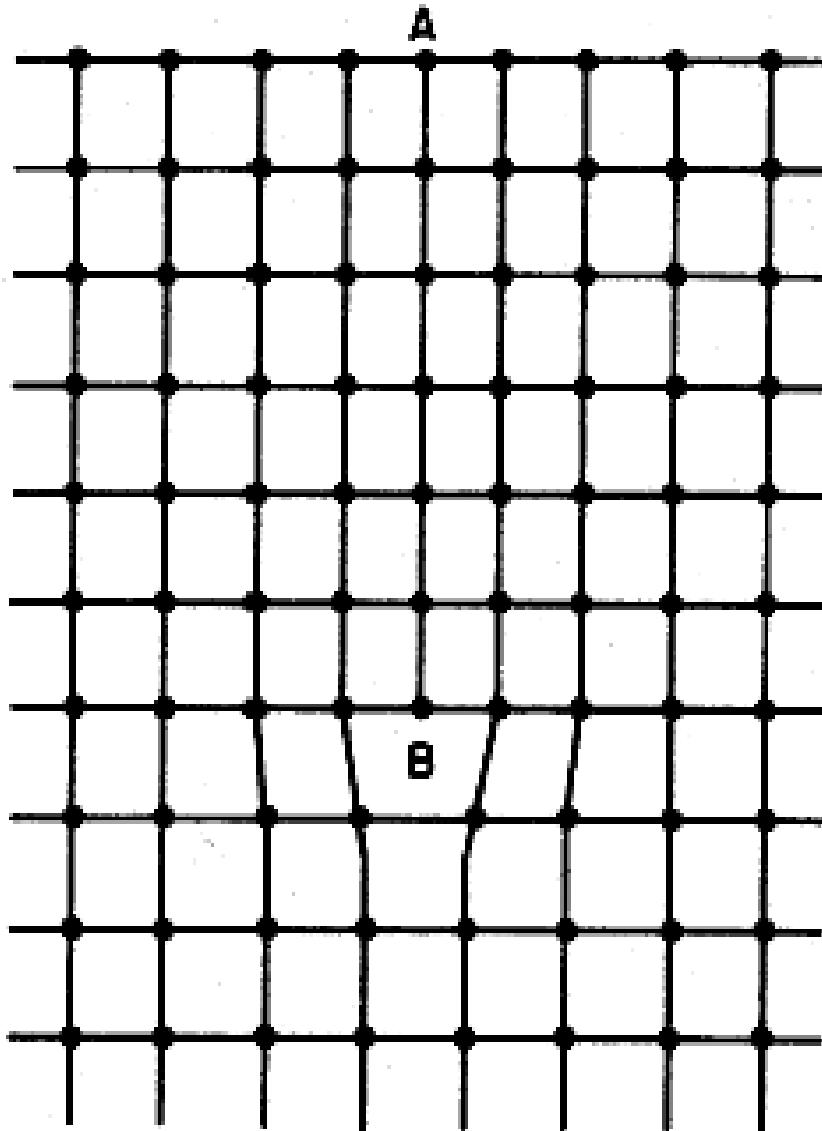
(a) Schottky defect



(b) Frenkel defect

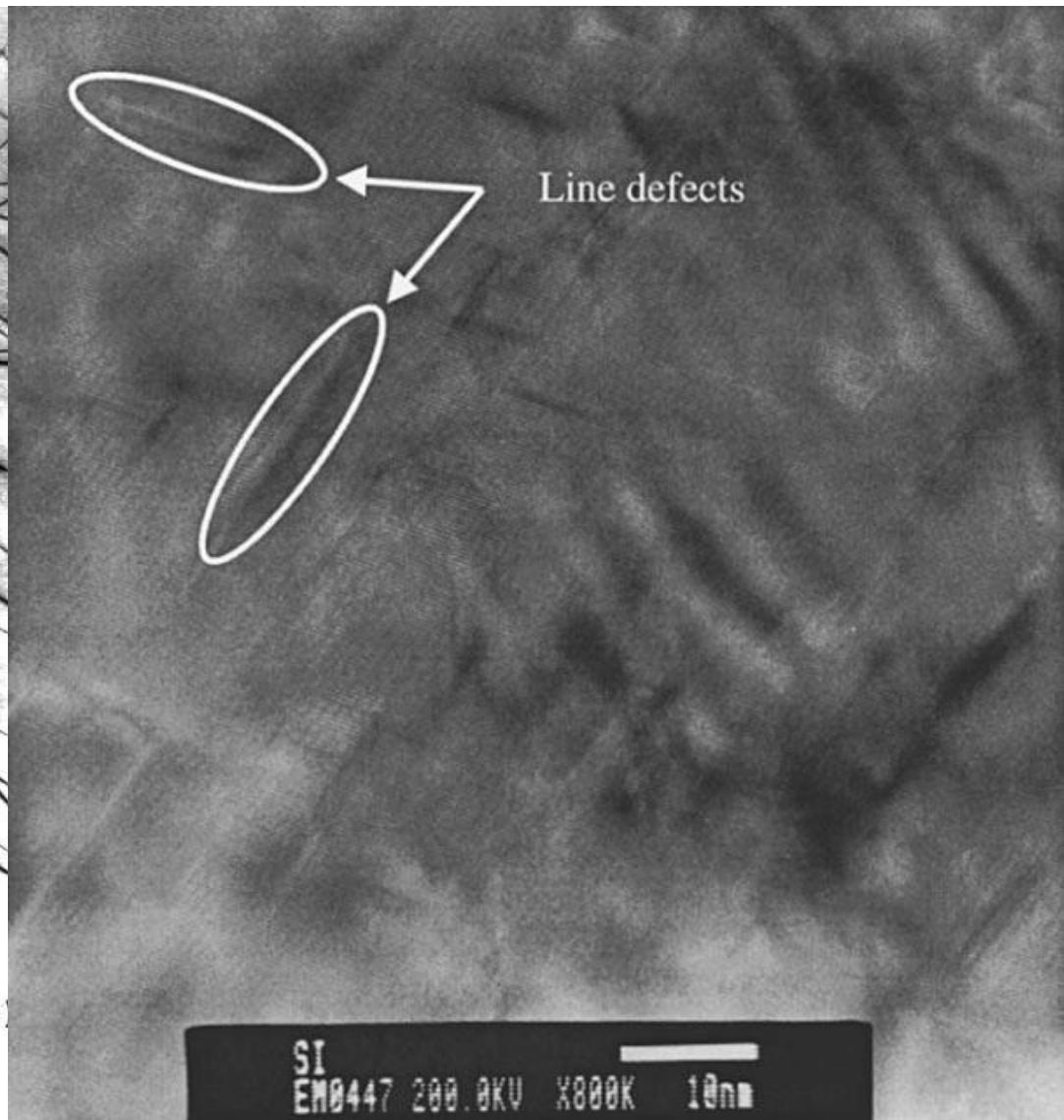
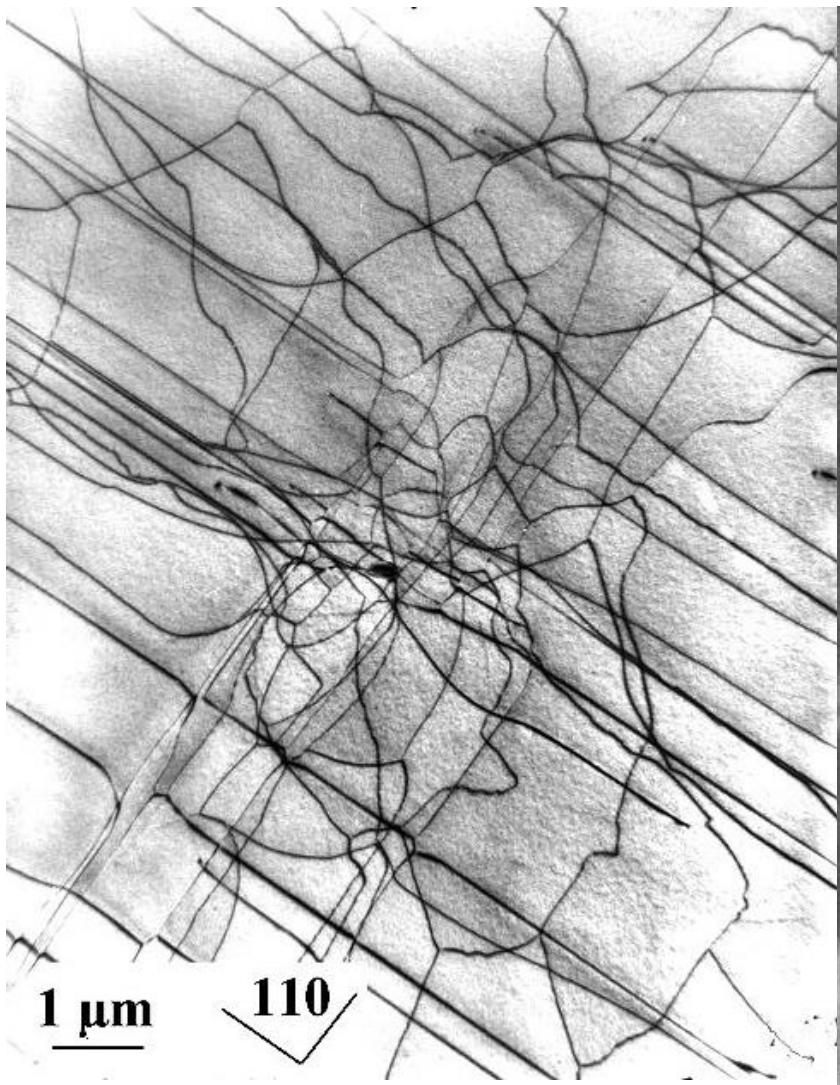


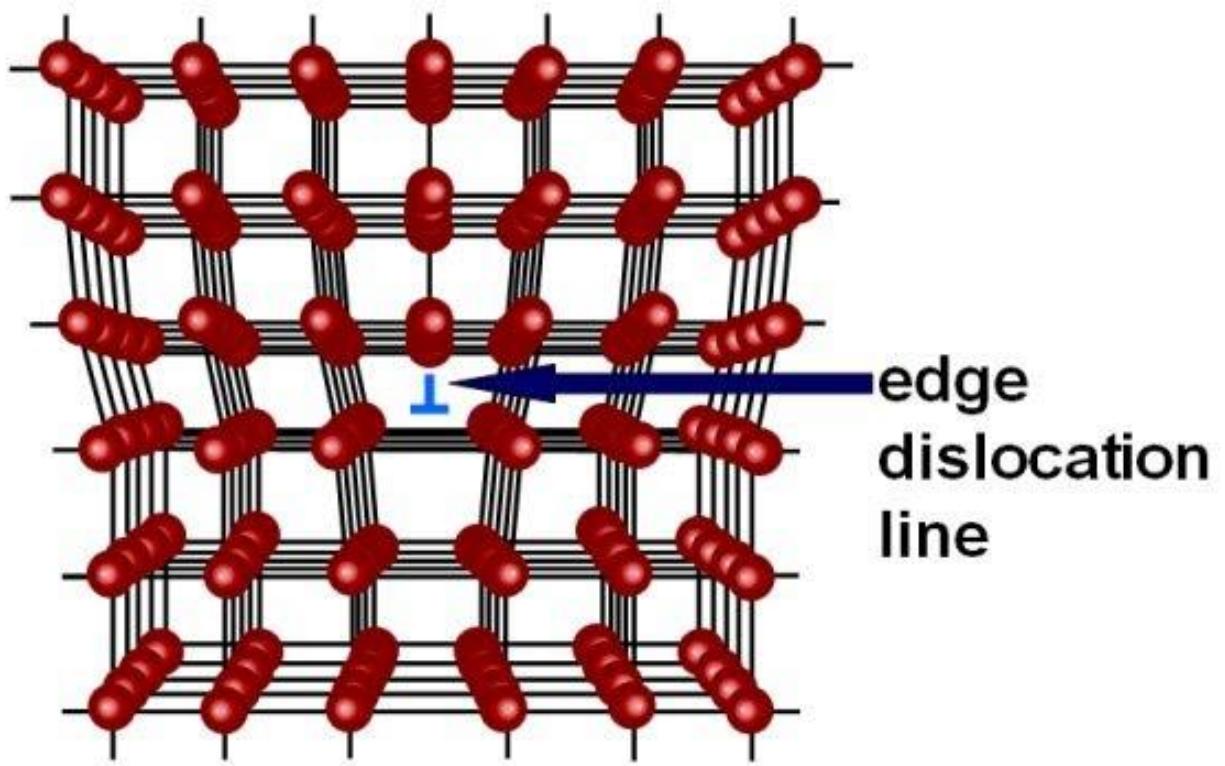
crystal defects result in **distortion** of crystal lattice



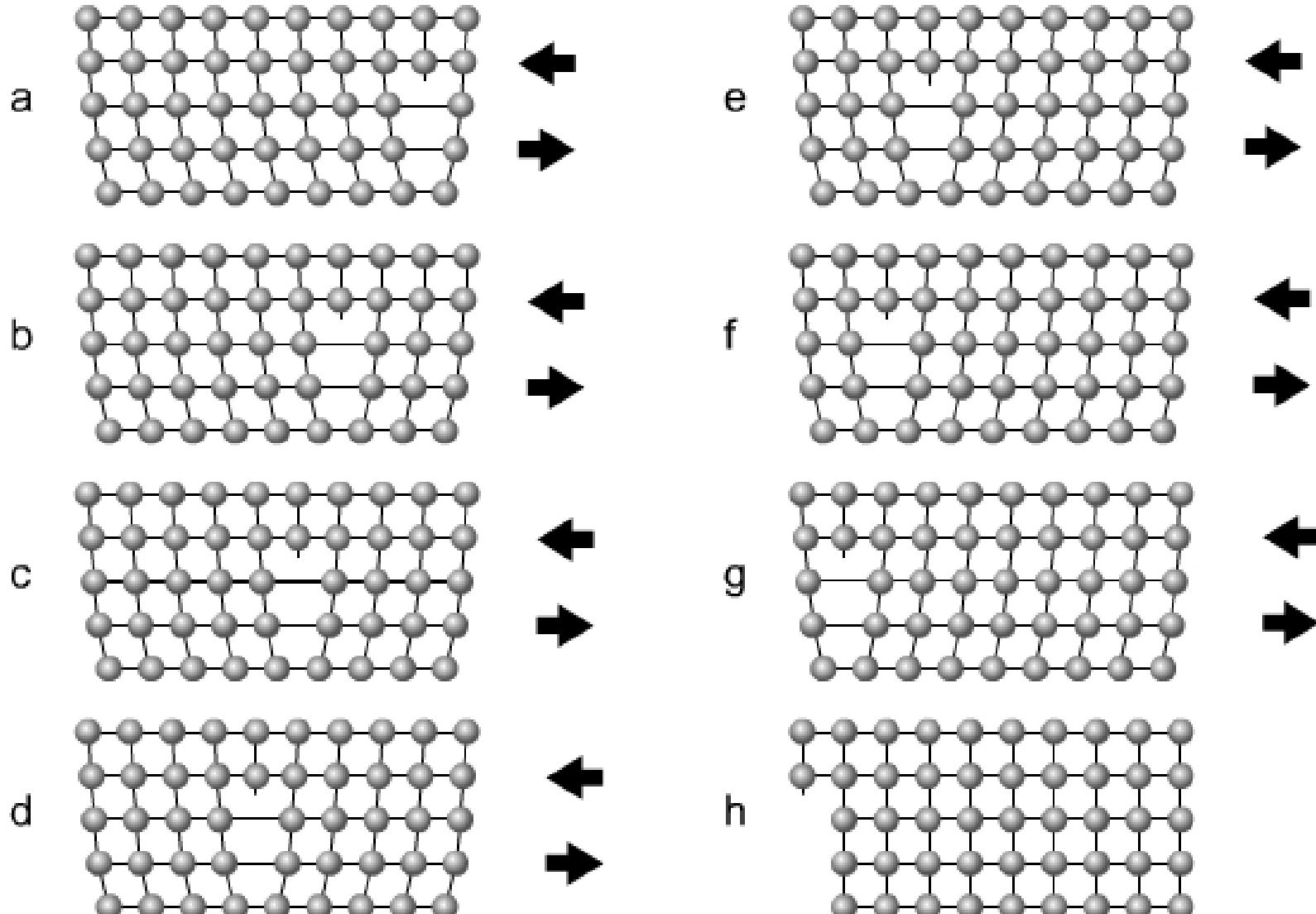
dislocation = linear defect

TEM
Si surface



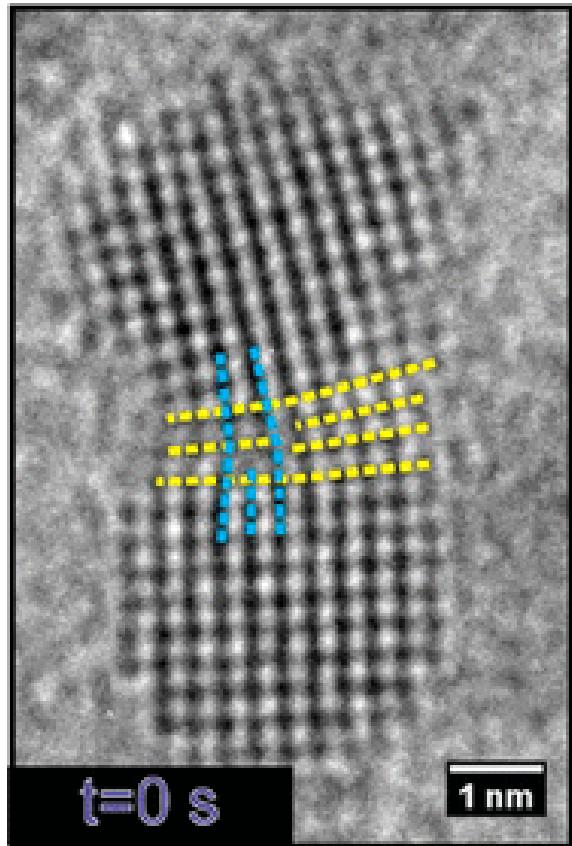


connected dislocations = **planar defects**

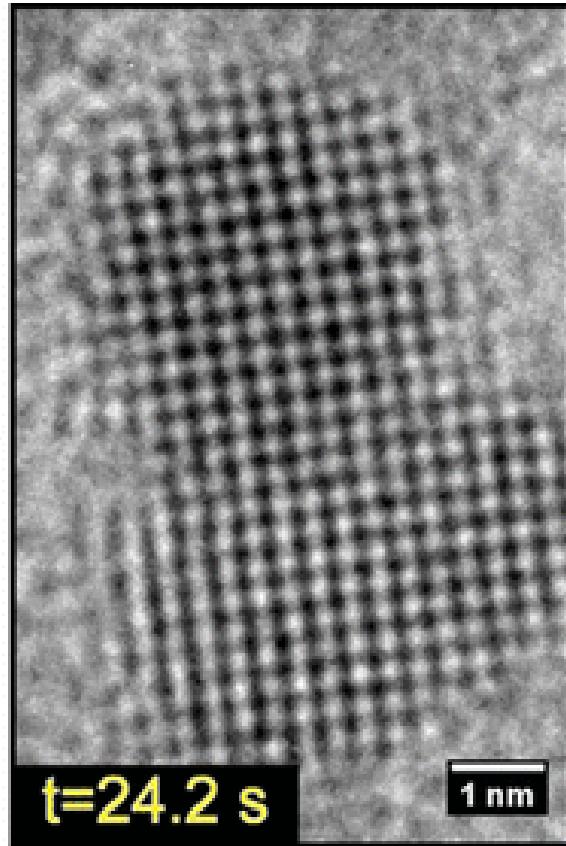


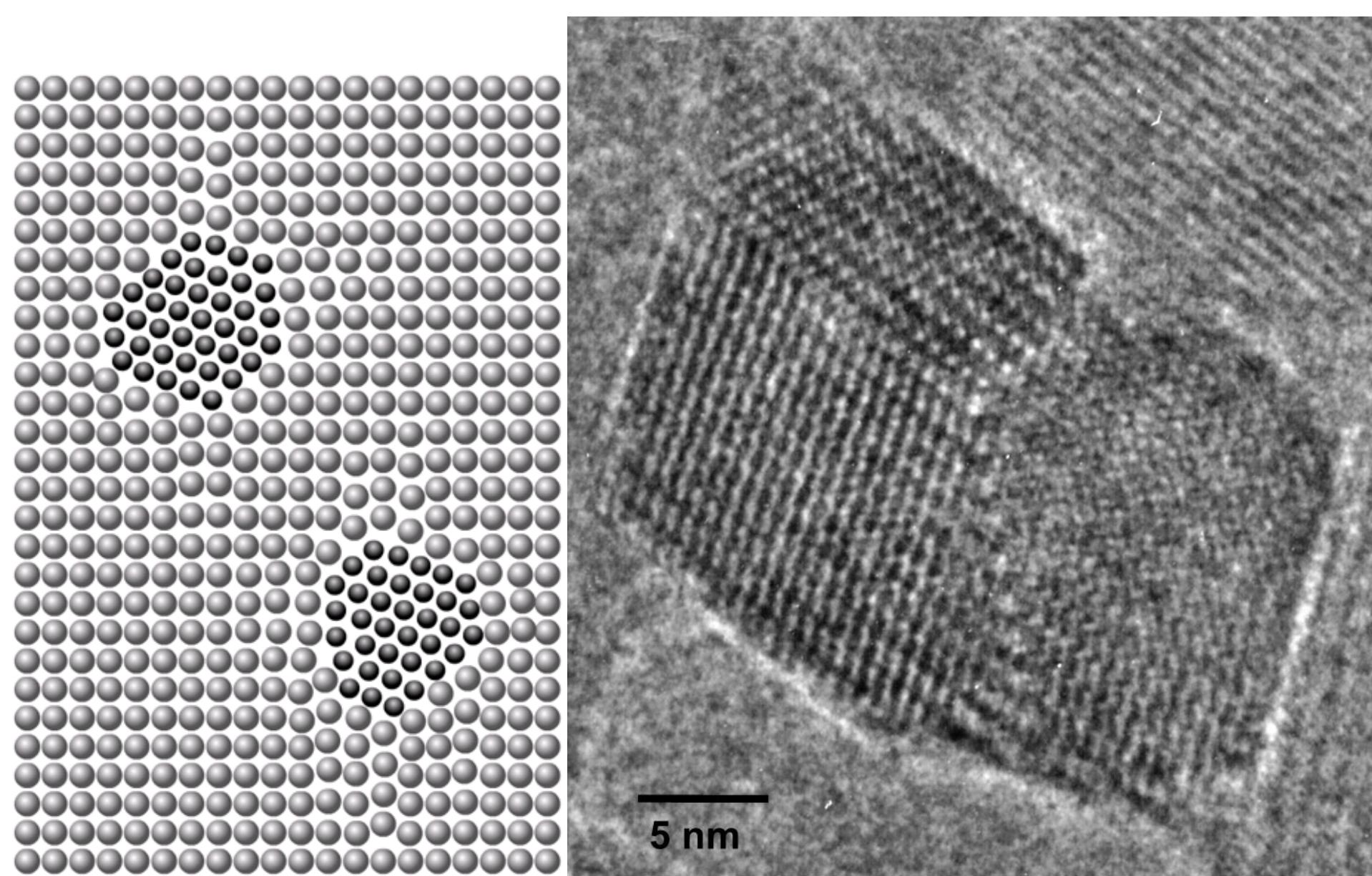
dislocations move in a crystal (at increased temperature)

PbTe crystal



Dislocation
Removal
Pathway





defect clustering above solubility threshold